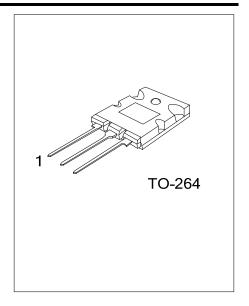
# UTC UNISONIC TECHNOLOGIES CO., LTD

75NM65 **Power MOSFET** 

# **75A, 650V N-CHANNEL** SUPER-JUNCTION MOSFET

#### DESCRIPTION

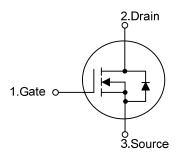
The UTC 75NM65 is a Super Junction MOSFET Structure and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and a high rugged avalanche characteristics. This power MOSFET is usually used at AC-DC converters for power applications.



#### **FEATURES**

- \*  $R_{DS(ON)} \le 48m\Omega$  @  $V_{GS}$ =10V,  $I_D$ =37.5A
- \* Fast switching capability
- \* Avalanche energy tested
- \* Improved dv/dt capability, high ruggedness

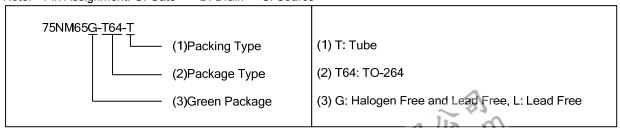
#### **SYMBOL**



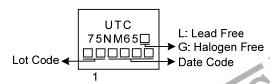
#### **ORDERING INFORMATION**

Ordering Number		Deelsese	Pin Assignment			Deelsing	
Lead Free	Halogen Free	Package	1	2	3	Packing	
75NM65L-T64-T	75NM65G-T64-T	TO-264	G	D	S	Tube	

Note: Pin Assignment: G: Gate D: Drain S: Source



#### **MARKING**



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# ABSOLUTE MAXIMUM RATINGS (T<sub>C</sub> =25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT	
Drain-Source Voltage		$V_{DSS}$	650	V	
Gate-Source Voltage		$V_{GSS}$	±30	V	
Drain Current	Continuous	I <sub>D</sub>	75	Α	
	Pulsed (Note 2)	I <sub>DM</sub>	150	Α	
Avalanche Energy	Single Pulsed (Note 3)	E <sub>AS</sub>	1711	mJ	
Peak Diode Recovery dv/dt (Note 4)		dv/dt	6	V/ns	
Power Dissipation		$P_{D}$	446	W	
Junction Temperature		$T_J$	+150	°C	
Storage Temperature Range		T <sub>STG</sub>	-55 ~ <b>+</b> 150	°C	

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 3. L=10mH,  $I_{AS}$ =18.5A,  $V_{DD}$ =50V,  $R_{G}$ =25 $\Omega$ , Starting  $T_{J}$  = 25 $^{\circ}$ C.
- 4.  $I_{SD} \le 30A$ , di/dt  $\le 200A/\mu s$ ,  $V_{DD} \le V_{(BR)DSS}$ ,  $T_J = 25^{\circ}C$ .

#### **THERMAL DATA**

PARAMETER	SYMBOL	RATING	UNIT	
Junction to Ambient	$\theta_{JA}$	40	°C/W	
Junction to Case	0.ic	0.28	°C/W	

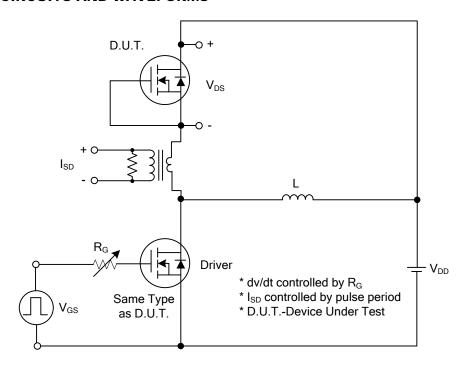
#### **ELECTRICAL CHARACTERISTICS** (T<sub>J</sub>=25°C, unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT		
OFF CHARACTERISTICS								
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	$V_{GS}$ =0V, $I_D$ =250 $\mu$ A	650			V		
Drain-Source Leakage Current	I <sub>DSS</sub>	V <sub>DS</sub> =650V, V <sub>GS</sub> =0V			10	μΑ		
Gate-Source Leakage Current	I <sub>GSS</sub>	V <sub>DS</sub> =0V ,V <sub>GS</sub> =±30V			±100	nA		
ON CHARACTERISTICS								
Gate Threshold Voltage	$V_{GS(TH)}$	$V_{DS}=V_{GS}$ , $I_D=250\mu A$	2.5		4.5	V		
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =37.5A			48	mΩ		
DYNAMIC PARAMETERS								
Input Capacitance	C <sub>ISS</sub>			6400		pF		
Output Capacitance	Coss	V <sub>GS</sub> =0V, V <sub>DS</sub> =25V, f=1.0MHz		4400		pF		
Reverse Transfer Capacitance	$C_{RSS}$			280		pF		
SWITCHING PARAMETERS								
Total Gate Charge (Note 1)	$Q_G$	\/ -520\/ \/ -40\/		220		nC		
Gate to Source Charge	$Q_GS$	$V_{DS}$ =520V, $V_{GS}$ =10V, $I_{D}$ =75A , $I_{G}$ =1mA (Note 1, 2)		29		nC		
Gate to Drain Charge	$Q_GD$			89		nC		
Turn-ON Delay Time (Note 1)	$t_{D(ON)}$			30		ns		
Rise Time	$t_R$	V <sub>DD</sub> =100V, V <sub>GS</sub> =10V,		28		ns		
Turn-OFF Delay Time	t <sub>D(OFF)</sub>	$I_D$ =75A, R <sub>G</sub> =3.3Ω (Note 1, 2)		130		ns		
Fall-Time	t⊧			29		ns		
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS								
Maximum Body-Diode Continuous Current	Is	3			75	Α		
Maximum Body-Diode Pulsed Current	I <sub>SM</sub>	2 118	0		150	Α		
Drain-Source Diode Forward Voltage (Note 1)	$V_{SD}$	I <sub>S</sub> =75A, V <sub>GS</sub> =0V	, ,		1.4	V		
Body Diode Reverse Recovery Time (Note 1)	t <sub>rr</sub>	I <sub>S</sub> =75A, V <sub>GS</sub> =0V,		710		ns		
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	dl <sub>F</sub> /dt=100A/µs		16.4		μC		

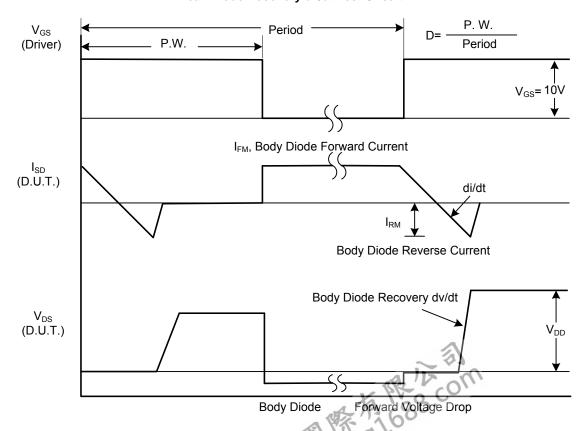
Notes: 1. Pulse Test : Pulse width ≤ 300µs, Duty cycle ≤ 2%.

2. Essentially independent of operating temperature.

#### ■ TEST CIRCUITS AND WAVEFORMS



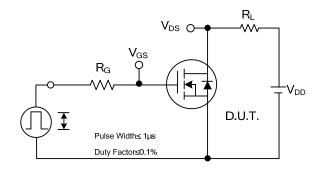
#### Peak Diode Recovery dv/dt Test Circuit

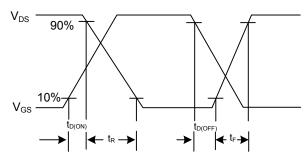


Peak Diode Recovery dv/dt Waveforms

75NM65 **Power MOSFET** 

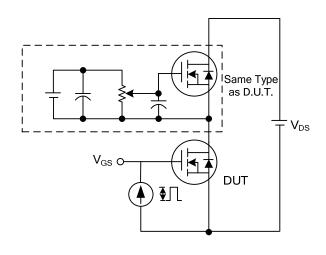
#### **TEST CIRCUITS AND WAVEFORMS**

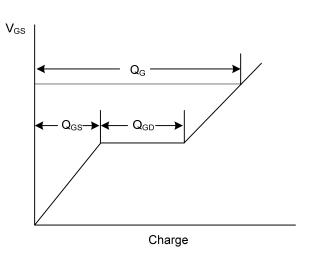




**Switching Test Circuit** 

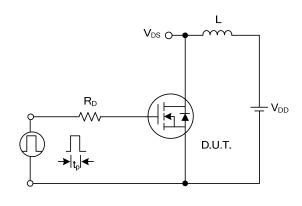
**Switching Waveforms** 

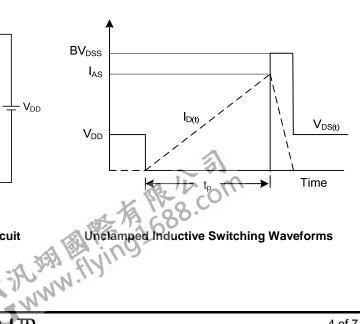




**Gate Charge Test Circuit** 

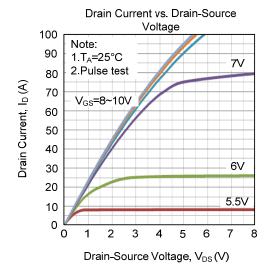
**Gate Charge Waveform** 

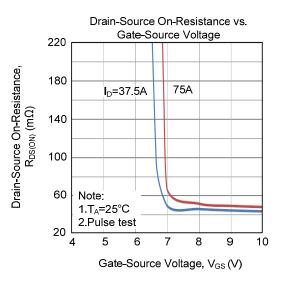


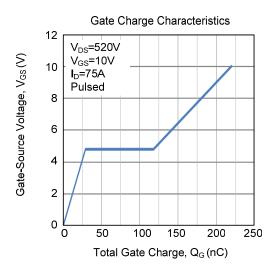


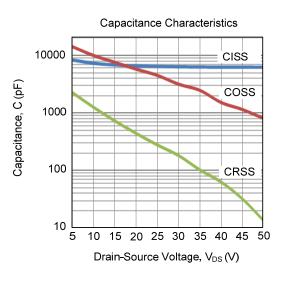
**Unclamped Inductive Switching Test Circuit** 

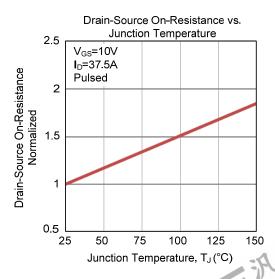
#### **■ TYPICAL CHARACTERISTICS**

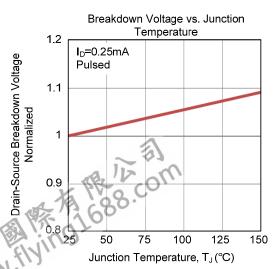




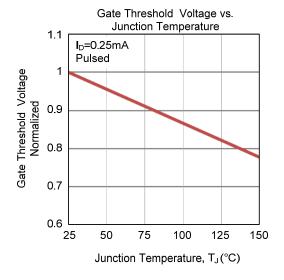


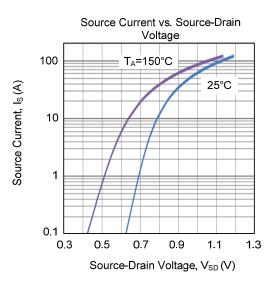


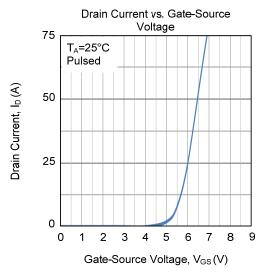


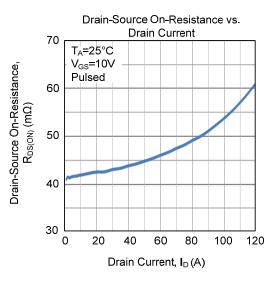


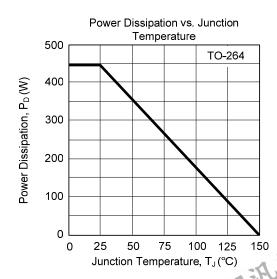
## **■ TYPICAL CHARACTERISTICS (Cont.)**

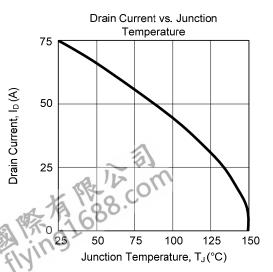




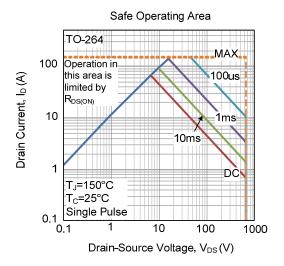








### ■ TYPICAL CHARACTERISTICS (Cont.)



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